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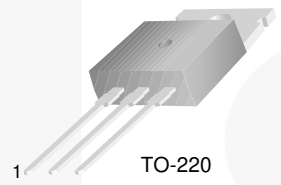
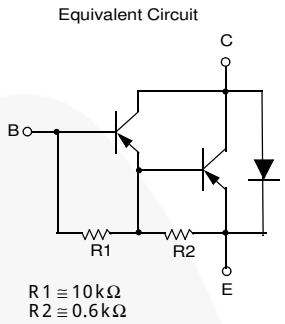
November 2014

TIP115 / TIP117
PNP Epitaxial Silicon Darlington Transistor

Features

- Monolithic Construction with Built-in Base-Emitter Shunt Resistors
- High DC Current Gain:
  h_{FE} = 1000 @ V_{CE} = -4 V, I_C = -1 A (Minimum)
- Low Collector-Emitter Saturation Voltage
- Industrial Use
- Complementary to TIP110 / TIP111 / TIP112





Ordering Information

Part Number	Top Mark	Package	Packing Method
TIP115	TIP115	TO-220 3L (Single Gauge)	Bulk
TIP117TU	TIP117	TO-220 3L (Single Gauge)	Rail

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at T_C = 25°C unless otherwise noted.

Symbol	Parameter		Value	Unit
V_{CBO}	Collector-Base Voltage	TIP115	-60	V
		TIP117	-100	
V_{CEO}	Collector-Emitter Voltage	TIP115	-60	V
		TIP117	-100	
V_{EBO}	Emitter-Base Voltage		-5	V
I_C	Collector Current (DC)		-2	A
I_{CP}	Collector Current (Pulse)		-4	A
I_B	Base Current (DC)		-50	mA
T_J	Junction Temperature		150	°C
T_{STG}	Storage Temperature Range		-65 to 150	°C

Thermal Characteristics

Values are at T_C = 25°C unless otherwise noted.

Symbol	Parameter	Value	Unit
P_C	Collector Dissipation (T_A = 25°C)	2	W
	Collector Dissipation (T_C = 25°C)	50	

Electrical Characteristics[1]

Values are at T_C = 25°C unless otherwise noted.

Symbol	Parameter		Conditions	Min.	Max.	Unit
V_{CEO}(sus)	Collector-Emitter Sustaining Voltage	TIP115	I_C = -30 mA, I_B = 0	-60		V
		TIP117		-100		
I_{CEO}	Collector Cut-Off Current	TIP115	V_{CE} = -30 V, I_B = 0		-2	mA
		TIP117	V_{CE} = -50 V, I_B = 0		-2	
I_{CBO}	Collector Cut-Off Current	TIP115	V_{CB} = -60 V, I_E = 0		-1	mA
		TIP117	V_{CB} = -100 V, I_E = 0		-1	
I_{EBO}	Emitter Cut-Off Current		V_{EB} = -5 V, I_C = 0		-2	mA
h_{FE}	DC Current Gain		V_{CE} = -4 V, I_C = -1 A	1000		
			V_{CE} = -4 V, I_C =- 2 A	500		
V_{CE}(sat)	Collector-Emitter Saturation Voltage		I_C = -2 A, I_B = -8 mA		-2.5	V
V_{BE}(on)	Base-Emitter On Voltage		V_{CE} = -4 V, I_C = -2 A		-2.8	V
C_{ob}	Output Capacitance		V_{CB} = -10 V, I_E = 0, f = 0.1 MHz		200	pF

Note:

1. Pulse test: pw ≤ 300 μs, duty cycle ≤ 2%.

Typical Performance Characteristics

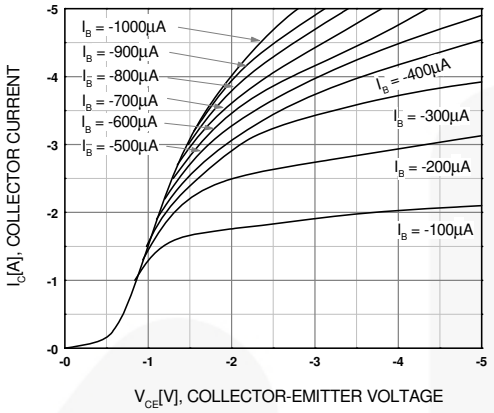


Figure 1. Static Characteristic

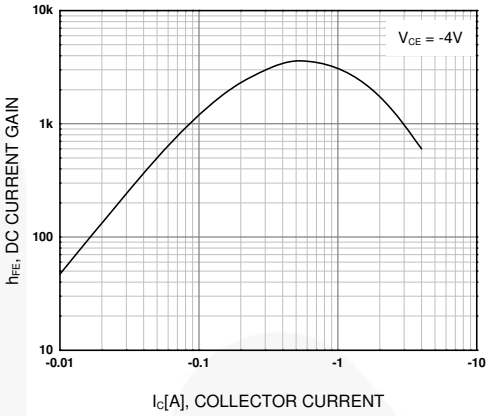


Figure 2. DC Current Gain

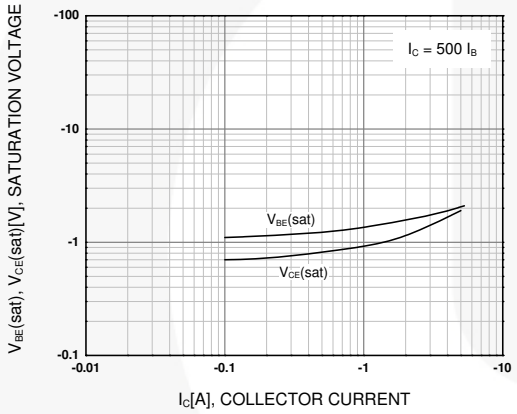


Figure 3. Collector-Emitter Saturation Voltage and Base-Emitter Saturation Voltage

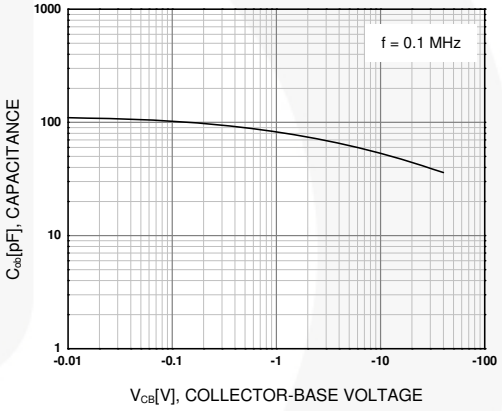


Figure 4. Collector Output Capacitance

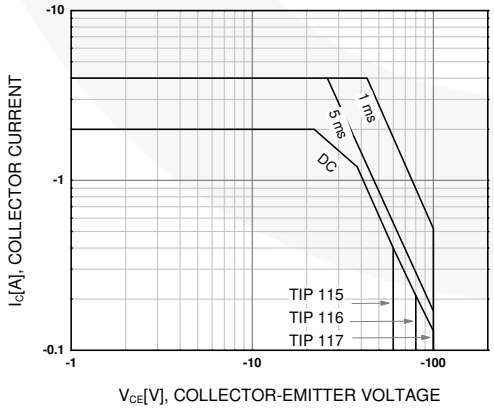


Figure 5. Safe Operating Area

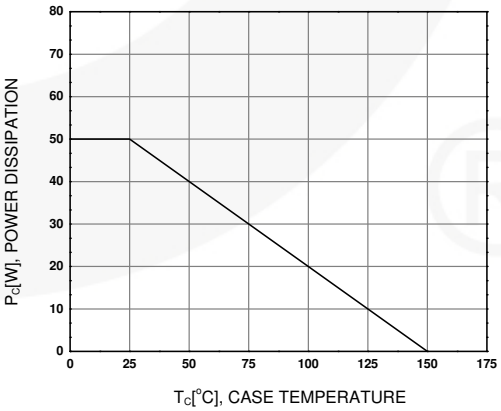


Figure 6. Power Derating

Physical Dimensions

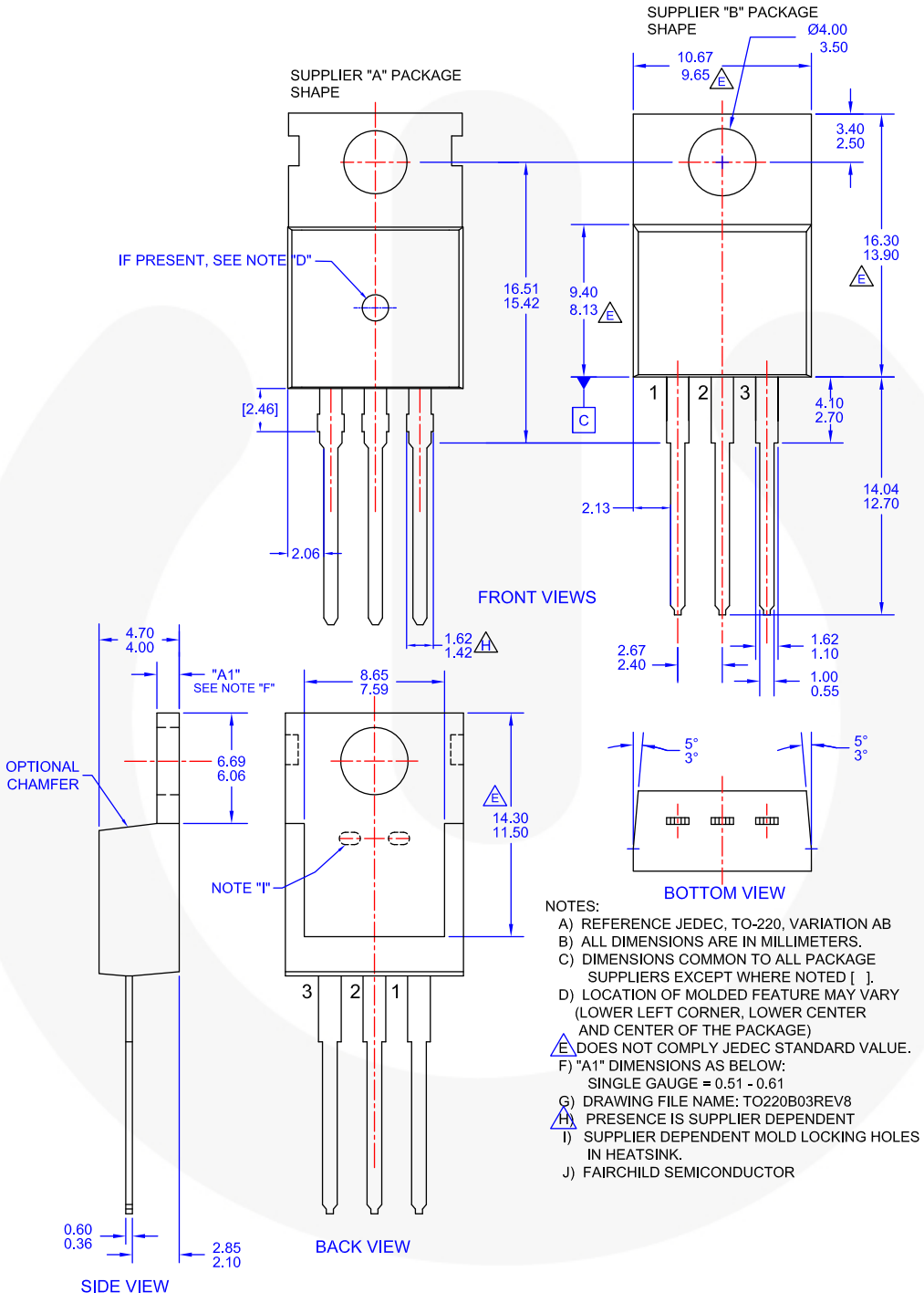


Figure 7. TO-220, MOLDED, 3LEAD, JEDEC VARIATION AB

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